

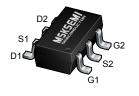


Product data sheet

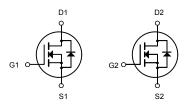
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AO6800-MS HF Compiance







Dual N-Channel MOSFET

Description

The AO6800-MS uses advanced trench technology to provide excellent RDS(ON), low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a

Battery protection or in other Switching application.

General Features

 $V_{DS} = 30V I_D = 4.5 A$

 $R_{DS(ON)} < 38m\Omega @ V_{GS}=10 V$

Application

Battery protection

Load switch

Uninterruptible power supply

Absolute Maximum Ratings@Tj=25°C(unless otherwise specified)

Symbol	Parameter	Rating	Units
V _{DS}	Drain-Source Voltage	30	V
V _{GS}	Gate-Source Voltage	<u>+</u> 12	V
I _D @T _A =25℃	Drain Current, V _{GS} @ 4.5V ³	4.5	A
Ідм	Pulsed Drain Current ¹	15	А
P _D @T _A =25℃	Total Power Dissipation	1.25	W
Тѕтс	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C
Rthj-a	Maximum Thermal Resistance, Junction- 125 °C/W ambient ³		°C/W



Electrical Characteristics (T_J=25°C unless otherwise specified)

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
Off Charac	teristic			1		
V _{(BR)DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250µA	30	-	-	V
IDSS	Zero Gate Voltage Drain Current	V _{DS} =30V, V _{GS} =0V,	-	-	1.0	μA
I _{GSS}	Gate to Body Leakage Current	V _{DS} =0V, V _{GS} = ±20V	-	-	±100	nA
On Charac	teristics					
$V_{GS(th)}$	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250µA	1.0	1.5	2.5	V
	Static Drain-Source on-Resistance	V _{GS} =10V, I _D =4A	-	29	38	mΩ
$R_{DS(on)}$	note2	V _{GS} =4.5V, I _D =3A	-	45	65	
Dynamic C	Characteristics			•		
C _{iss}	Input Capacitance		-	233	-	pF
Coss	Output Capacitance	→ V _{DS} =15V, V _{GS} =0V, → f=1.0MHz	-	44	-	pF
Crss	Reverse Transfer Capacitance		-	33	-	pF
Qg	Total Gate Charge	(1 - 15)(1 - 20)	-	3	-	nC
Q _{gs}	Gate-Source Charge	─ V _{DS} =15V, I _D =2A, ─ V _{GS} =10V	-	0.5	-	nC
Q_{gd}	Gate-Drain("Miller") Charge	VGS-10V	-	0.8	-	nC
Switching	Characteristics					
t _{d(on)}	Turn-on Delay Time		-	4	-	ns
tr	Turn-on Rise Time	$-V_{DS}=15V,$	-	2.1	-	ns
t _{d(off)}	Turn-off Delay Time	─ I _D =4A, R _{GEN} =3Ω, ─ V _{GS} =10V	-	15	-	ns
t _f	Turn-off Fall Time	- V _{GS} -10V	-	3.2	-	ns
Drain-Sou	rce Diode Characteristics and Maxim	um Ratings				
ls	Maximum Continuous Drain to Source Diode Forward Current		-	-	4.5	А
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current		-	-	16	Α
V_{SD}	Drain to Source Diode Forward Voltage		-	-	1.2	V

Notes:1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature

2. Pulse Test: Pulse Width≤300µs, Duty Cycle≤0.5%





Typical Performance Characteristics

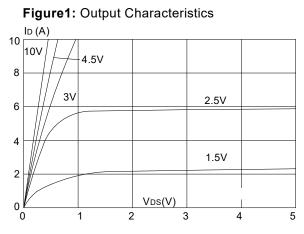


Figure 3:On-resistance vs. Drain Current RDS(ON) (mΩ)

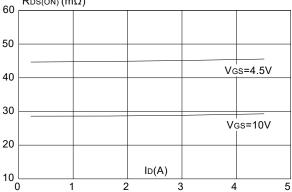
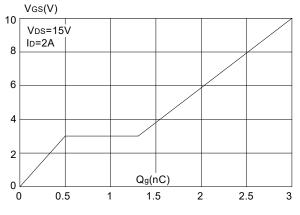
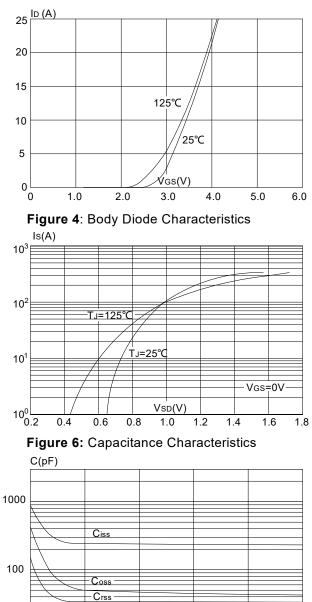


Figure 5: Gate Charge Characteristics





VDS(V)

15

20

25

10

10

0

5

Figure 2: Typical Transfer Characteristics

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Figure 7: Normalized Breakdown Voltage vs. Junction Temperature

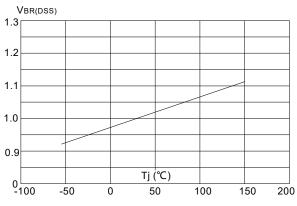
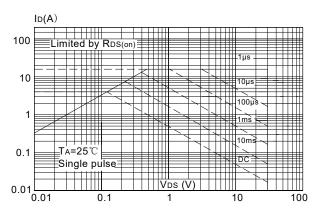
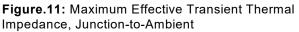


Figure 9: Maximum Safe Operating Area





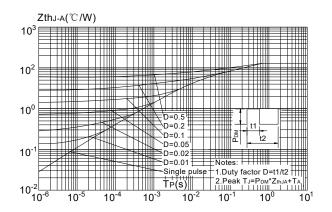


Figure 8: Normalized on Resistance vs. Junction Temperature

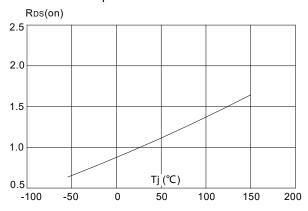
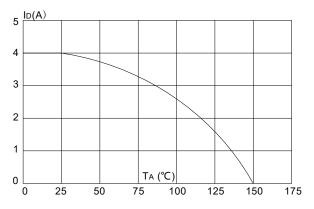


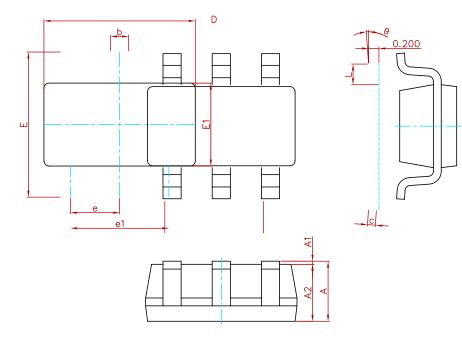
Figure 10: Maximum Continuous Drain Current vs. Ambient Temperature





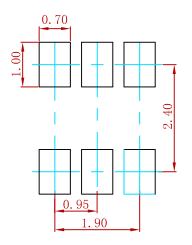


PACKAGE MECHANICAL DATA



Symbol	Dimensions In Millimeters		Dimensions In Inches	
Symbol	Min.	Max.	Min.	Max.
Α	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
С	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E1	1.500	1.700	0.059	0.067
E	2.650	2.950	0.104	0.116
е	0.950(BSC)	0.037	(BSC)
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°

Suggested Pad Layout



Note:

Controlling dimension:in millimeters.
 General tolerance:± 0.05mm.
 The pad layout is for reference purposes only.

REEL SPECIFICATION

P/N	PKG	QTY
AO6800-MS	SOT-23-6L	3000





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